

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

| Specification                  | Test/Inspection Condition   | Reference/Spec  |
|--------------------------------|---|---|
| Operating Temperature          | -30° to 85°C<br>Ambient Environment   | Individual Data Sheet                                       |
| Storage Temperature            | -55° to 100° C<br>Ambient Environment   | Individual Model Data Sheet                                 |
| Temperature Cycling            | -55° to 100°C, 100 cycles   | MIL-STD-883, Method 1010, Condition B, except 100°C         |
| Mechanical Shock               | 100g, 6ms sawtooth, 3 shocks each direction 3 axes (total 18)   | MIL-STD-202, Method 213, Condition I                        |
| Vibration (High Frequency)     | 20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)   | MIL-STD-202, Method 204, Condition D                        |
| Constant Acceleration          | Y1 plane only, 5 Kg   | MIL-STD-883, Method 2001, Condition A, except Y1 plane only |
| HAST                           | 130°C, 85% RH, 96 hours   | JESD22-A110   |
| Solder Reflow Profile          | Sn-Pb Eutetic Process: 240°C peak<br>PB-Free Process: 250°C peak  | J-STD-020, Table 4-1, 4-2 and 5-2; Figure 5-1               |
| Marking Resistance to Solvents | Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C;<br>distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C | MIL-STD-202, Method 215                                     |